

## ITL Part Code - CU272



### **Specification**

*Material: OFHC Copper*

*Oxygen free high conductivity (OFHC) copper is a suitable sealing material for bakeable UHV systems because of its good conformity with the thermal expansion coefficient of stainless steel as well as its essentially lower hardness (approx. 85 Brinell).*

<i>For Flange OD</i>	<i>D1</i>	<i>D2</i>	<i>Pack size</i>
304 (12.00)	272 (10.71)	254 (10.00)	5

